

October 2013

FDPF8N50NZF N-Channel UniFETTM II FRFET[®] MOSFET

500 V, 7 A, 1 Ω

Features

- + $R_{DS(on)}$ = 850 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 3.25 A
- Low Gate Charge (Typ. 14 nC)
- Low C_{rss} (Typ. 5 pF)
- 100% Avalanche Tested
- Improve dv/dt Capability
- ESD Improved Capability
- RoHS Compliant

Applications

- LCD/LED TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFETTM II MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on advanced planar stripe and DMOS technology. This advanced MOSFET family has the smallest on-state resistance among the planar MOSFET, and also provides superior switching performance and higher avalanche energy strength. In addition, internal gate-source ESD diode allows UniFET II MOSFET to withstand over 2kV HBM surge stress. The body diode's reverse recovery performance of UniFET II FRFET® MOSFET has been enhanced by lifetime control. Its t_{rr} is less than 100nsec and the reverse dv/dt immunity is 15V/ns while normal planar MOSFETs have over 200nsec and 4.5V/nsec respectively. Therefore, it can remove additional component and improve system reliability in certain applications in which the performance of MOSFET's body diode is significant. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

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Symbol	Parameter			FDPF8N50NZF	Unit
V _{DSS}	Drain to Source Voltage			500	V
V _{GSS}	Gate to Source Voltage			±25	V
ID	Drain Current	- Continuous (T _C = 25 ^o C)		7*	Α
		- Continuous (T _C = 100 ^o C)		4.2*	
I _{DM}	Drain Current	- Pulsed (Note 1)	28*	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		(Note 2)	93	mJ
I _{AR}	Avalanche Current (Note 1)		(Note 1)	7	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		(Note 1)	13	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		(Note 3)	20	V/ns
P _D	Power Dissipation	(T _C = 25°C)		40	W
		- Derate above 25°C		0.32	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose,			300	°C
11	1/8" from Case for 5 Seconds		500	C	

SymbolParameterFDPF8N50NZFUnitR_{0JC}Thermal Resistance, Junction to Case, Max.3.1°C/WR_{0JA}Thermal Resistance, Junction to Ambient, Max.62.5°C/W

		Pack	age	Reel Size	Таре	e Width		Quantit	у	
		TO-2			N/A		50 units			
Electrica	l Char	racteristics T_c =	25°C unles	ss otherwi	se noted	·				
Symbol		Parameter			Test Conditions	;	Min.	Тур.	Max.	Uni
Off Charac	teristic	s								_
BV _{DSS}				I _D = 250μA, V _{GS} = 0V, T _C = 25 ^o C		500	-	_	V	
ΔBV_{DSS}		Drain to Source Breakdown Voltage Breakdown Voltage Temperature		$I_D = 250\mu$ A, Referenced to 25° C		-	0.5	-	V/°C	
/ ∆T _J Coeffici				V _{DS} = 500V, V _{GS} = 0V		_	-	10		
I _{DSS} Zero Gate Vo		ate Voltage Drain Curr	Voltage Drain Current		$V_{\rm DS} = 300V, V_{\rm GS} = 0V$ $V_{\rm DS} = 400V, T_{\rm C} = 125^{\rm o}{\rm C}$		_	_	100	μA
I _{GSS}	Gate to	Gate to Body Leakage Current		$V_{\rm DS} = \pm 25V, V_{\rm DS} = 0V$		-	-	±10	μA	
On Charac	teristic	s								
V _{GS(th)}	Gate T	hreshold Voltage		V _{GS} =	V _{DS} , I _D = 250μA		3.0	-	5.0	V
R _{DS(on)}		Drain to Source On Res	sistance		10V, I _D = 3.5A		-	0.85	1	Ω
9 _{FS}	Forwar	d Transconductance			20V, I _D = 3.5A		-	6.3	-	S
Dynamic C	haract	eristics			5					
C _{iss}		apacitance	-	V _{DS} = 25V, V _{GS} = 0V f = 1MHz		-	565	735	pF	
C _{oss}	Output	Capacitance				-	80	105	pF	
C _{rss}	Revers	e Transfer Capacitance	9			-	5	8	pF	
Q _{q(tot)}	Total G	ate Charge at 10V		$V_{DS} = 400V, I_D = 7A$ $V_{GS} = 10V$ (Note 4)		-	14	18	nC	
Q _{gs}	Gate to	Source Gate Charge				-	4	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge				-	6	-	nC	
Switching	Charac	teristics								
t _{d(on)}		n Delay Time		$V_{DD} = 250V, I_D = 7A$ $R_G = 25\Omega, V_{GS} = 10V$ (Note 4)		-	17	45	ns	
t _r	Turn-O	n Rise Time	_			-	34	80	ns	
t _{d(off)}	Turn-O	ff Delay Time				-	-	43	95	ns
t _f	Turn-O	ff Fall Time				-	27	60	ns	
Drain-Sou	rce Dio	de Characteristic	S	·						
I _S	Maximum Continuous Drain to Source Diode Forward Current				-	-	7	A		
I _{SM}	Maximu	Maximum Pulsed Drain to Source Diode			Forward Current		-	-	28	Α
V _{SD}	Drain to	n to Source Diode Forward Voltage		V _{GS} = 0V, I _{SD} = 7A		-	-	1.5	V	
t _{rr}	Reverse	e Recovery Time		V _{GS} =	0V, I _{SD} = 7A		-	80	- / -	ns
Q _{rr}	Reverse	e Recovery Charge		$dI_{\rm F}/dt = 100A/\mu s$		_	0.3	· -	μC	

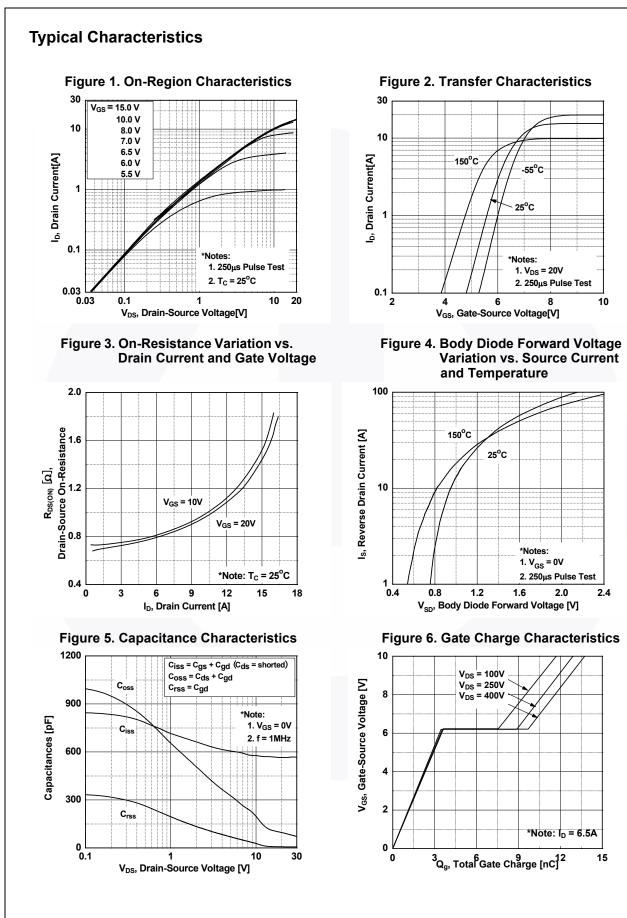
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2. L = 3.8mH, I_{AS} = 7A, V_DD = 50V, R_G = 25 Ω , Starting T_J = 25°C

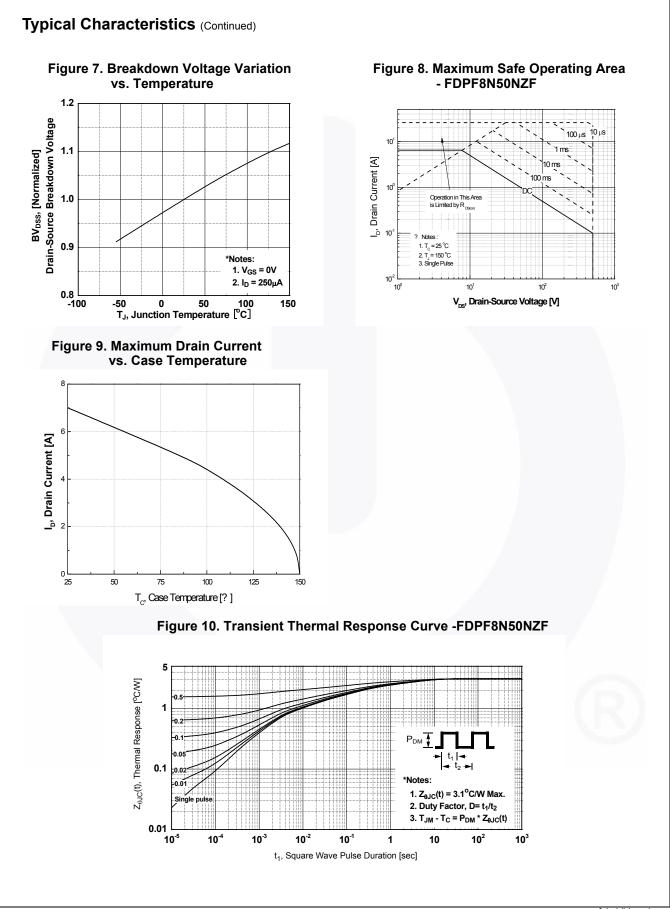
3. $I_{SD} \leq$ 7A, di/dt \leq 200A/µs, $V_{DD} \leq$ BV_{DSS}, Starting T_J = 25°C

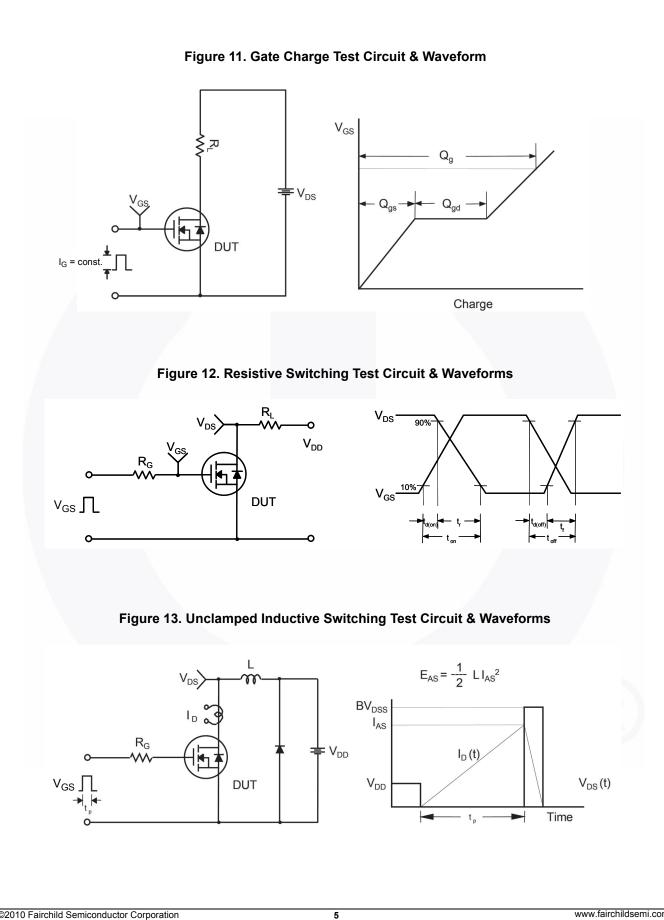
4. Essentially Independent of Operating Temperature Typical Characteristics



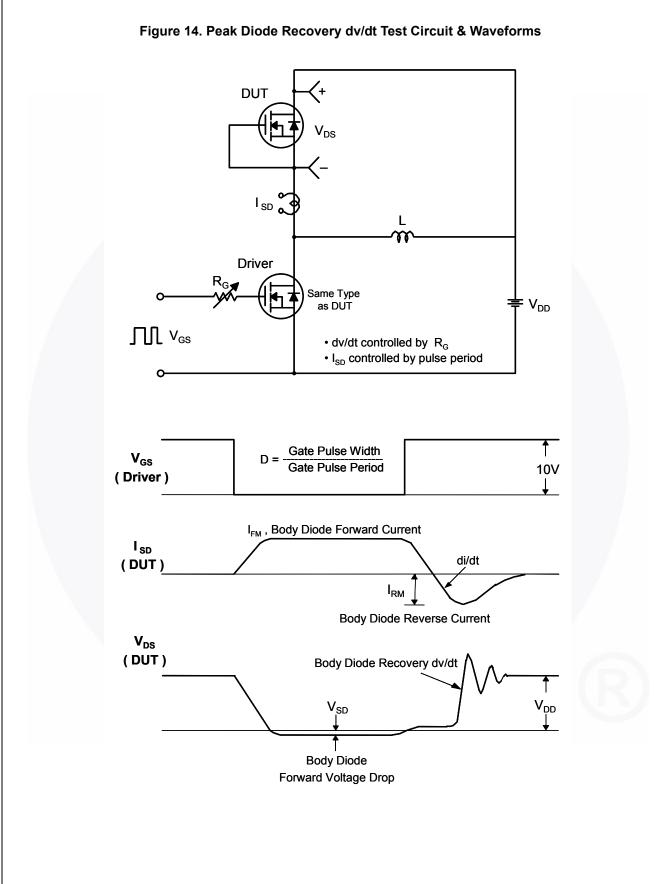


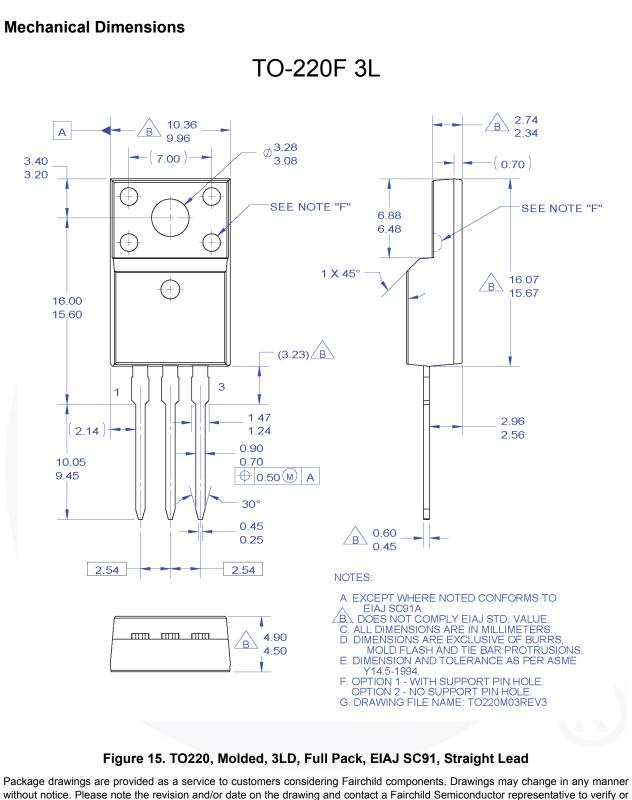
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Dimension in Millimeters

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